

L Number	Hits	Search Text	DB	Time stamp
1	1349463	sensor\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 12:57
2	1895	sensor\$3 and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:39
3	440	(sensor\$3 and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:40
4	389	((sensor\$3 and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8))) and (bond\$5 or connect\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:40
5	148663	(acceleration or pressure) near3 sensor\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:47
6	215	((acceleration or pressure) near3 sensor\$3) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:48
7	52	((acceleration or pressure) near3 sensor\$3) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:40
8	47	((((acceleration or pressure) near3 sensor\$3) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8))) and (bond\$5 or connect\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:47
9	6580	((acceleration or pressure) near3 sensor\$3) and ((semiconductor or silicon) near5 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:47
10	78	((((acceleration or pressure) near3 sensor\$3) and ((semiconductor or silicon) near5 substrate)) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/21 13:48